



日富光電有限公司 Sun Wealth Technology CO., LTD.



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熱固型可剝膠 CP-PCB626

CP-PCB626為加熱硬化型可剝離的耐焊油墨，具有快速硬化及良好的印刷性，乾燥後其耐熱性及可剝離性極優因此可以用於PCB 化錫/化銀製程中金手指的焊錫保護，使用後可完全剝除無任何殘膠(SCUM)而且耐化學品特佳,因此也可以進行抗電鍍製程。

CP-PCB626 is temporary solder mask ink designed for using in printed circuit fabrication for gold finger. It has fast curing speed, excellent printing properties and forming a tough protective film after thermal curing. The cured film will with stand solder heat, keeping excellent electrical, peelable properties, and chemicals resistance for gold plating.

SPECIFICATION:

Model Type	CP-PCB626
Color	Blue
Viscosity(cps)	1800±200 PS
Printing	11-24T mesh
Stencil thickness	50-100 mocron
Curing	OVEN 150°C±5°C, 30 mins
Resistance to molten solder	260±5 °C , 3 seconds, ≥ 2 times
Dilution	The addition of solvent is not recommended

Notice:

- 1.Viscosity measured by Brookfield VT04, using spindle NO.2 at 20 rpm, 25°C.
- 2.Curing type: By IR drying or box oven.
- 3.Shelf Life: 6 months at room temperature under 25°C.
- 4.Keep out the reach of children.
- 5.Safety and Handling: adequate ventilation is required.
- 6.The above information is for reference only.